ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INFORMATION CONNECTING	Bannockburn, Illinois, A	ll rights reserved untions.	inder both	This docume level parts, t	ent is a declarat he declaration e	on of the suncompasse	ubstances s all lower	within the manufact level materials for	urer listed which the	item. Note: i manufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Material					ls and Mfg Information			
Supplier Information													
Company name*	ique ID			Unique ID Authority				Respo	Response Date*				
onsemi	emi								2024-0	2024-04-24			
Contact Name	Title - Contact]	Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards	luct-Env-Stewards Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative			Phone -			Representative*			Email	Email - Representative*			
Product-Env-Stewards	riro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number	Mfr Item Name			Effective Date	Version	Ν	Manufacturing Site		Weight*	UOM	Unit Type	
1	NCP303150MNTWG	03150MNTWG Integrated Driver		MOSFFET			1	TH6		86.36325	mg	Each	
Manufacturing Proccess Information		·			•					·			
Terminal Plating / Grid Array Materia	Terminal Base Alloy		J-STD-020 MSL	Rating	Peak Proc	Process Body Temperature Max Time at Peak		k Tempera	Temperature Number of Reflow Cycles		cles		
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	seco	nds 3			
Comments													
evel 1 - maximum time at peak temperature d	uring soldering is 10-3	0 seconds											
for more information regarding material com	position please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et						
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.80036	mg	Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Iron (Fe)	7439-89-6		0.1632	mg
			Supplier	Copper (Cu)	7440-50-8		6.6236	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0054	mg
Clip Attach	0.1	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.0075	mg
			Supplier	Proprietary	Proprietary Data		0.0065	mg
			Supplier	Bismaleimide	13676-54-5		0.028	mg
			Supplier	PTFE	9002-84-0		0.058	mg
Die	2.76287	mg	Supplier	Silicon (Si)	7440-21-3		2.7629	mg
Die Attach Solder	4.40103	mg	Supplier	Silver (Ag)	7440-22-4		0.11	mg
			А	Lead (Pb)	7439-92-1	7a	4.071	mg
			Supplier	Tin (Sn)	7440-31-5		0.2201	mg
Lead Frame	32.9996	mg	Supplier	Silver (Ag)	7440-22-4		1.65	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0396	mg
			Supplier	Iron (Fe)	7439-89-6		0.792	mg
			Supplier	Copper (Cu)	7440-50-8		30.4916	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0264	mg
Mold Compound-Black	36.0995	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.3465	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1805	mg
			Supplier	Silica (SiO2)	14464-46-1		31.7676	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.805	mg
lating	2.99983	mg	Supplier	Tin (Sn)	7440-31-5		2.9998	mg
Wire Bond - Cu	0.200061	mg	Supplier	Palladium (Pd)	7440-05-3		0.0036	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.1963	mg